

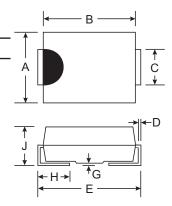
1.0A SURFACE MOUNT ULTRA-FAST RECTIFIER

Features

- Glass Passivated Die Construction
- **Diffused Junction**
- Ultra-Fast Recovery Time for High Efficiency
- Low Forward Voltage Drop, High Current Capability, and Low Power Loss
- Surge Overload Rating to 30A Peak
- Ideally Suited for Automated Assembly
- Lead Free Finish/RoHS Compliant (Note 5)

Mechanical Data

- Case: SMA
- Case Material: Molded Plastic. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020C
- Terminals: Lead Free Plating (Matte Tin Finish). Solderable per MIL-STD-202, Method 208
- Polarity: Cathode Band or Cathode Notch
- Marking: Type Number & Date Code: See Below
- Ordering Information: See Below
- Weight: 0.064 grams (approximate)



SMA						
Dim	Min Max					
Α	2.29	2.92				
В	4.00	4.60				
С	1.27	1.63				
D	0.15	0.31				
E	4.80	5.59				
G	0.10	0.20				
Н	0.76	1.52				
J	2.01	2.62				
All Dimensions in mm						

Maximum Ratings and Electrical Characteristics T_A = 25°C unless otherwise specified

Single phase, half wave, 60Hz, resistive or inductive load. For capacitive load, derate current by 20%.

Characteristic		Symbol	US1A	US1B	US1D	US1G	US1J	US1K	US1M	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage		V _{RRM} V _{RWM} V _R	50	100	200	400	600	800	1000	٧
RMS Reverse Voltage		V _{R(RMS)}	35	70	140	280	420	560	700	V
Average Rectified Output Current	@ $T_T = 75^{\circ}C$	lo				1.0				Α
Non-Repetitive Peak Forward Surge Currer 8.3ms Single half sine-wave Superimposed (JEDEC Method)	t on Rated Load	I _{FSM}				30				А
Forward Voltage Drop	@ I _F = 1.0A	V _{FM}		1.0		1.3		1.7		V
Peak Reverse Current at Rated DC Blocking Voltage	@ T _A = 25°C @ T _A = 100°C	I _{RM}				5.0 100				μА
Reverse Recovery Time (Note 2)		t _{rr}		5	0			75		ns
Typical Junction Capacitance (Note 1)		Cj		2	0			10		pF
Typical Thermal Resistance, Junction to Terminal		$R_{\theta JT}$	30						°C/W	
Operating and Storage Temperature Range		T _j , T _{STG}	-65 to +150					°C		

Ordering Information

Device*	Packaging	Shipping
US1x-13-F	SMA	5000/Tape & Reel

^{*}x = Device type, e.g. US1A-13-F.

Notes: 1. Measured with $I_F = 0.5A$, $I_R = 1.0A$, $I_{rr} = 0.25A$. See figure 5.

- 2. Measured at 1.0MHz and applied reverse voltage of 4.0V DC.
- 3. Unit mounted on PC board with 5.0 mm² (0.013 mm thick) copper pad as heat sink.
- 4. For Packaging Details, go to our website at http://www.diodes.com/datasheets/ap02007.pdf.
- 5. RoHS revision 13.2.2003. Glass and High Temperature Solder Exemptions Applied, see EU Directive Annex Notes 5 and 7.

Marking Information



XXXX = Product type marking code, ex. US1A ☐ = Manufacturers' code marking YWW = Date code marking Y = Last digit of year ex: 2 for 2002

WW = Week code 01 to 52



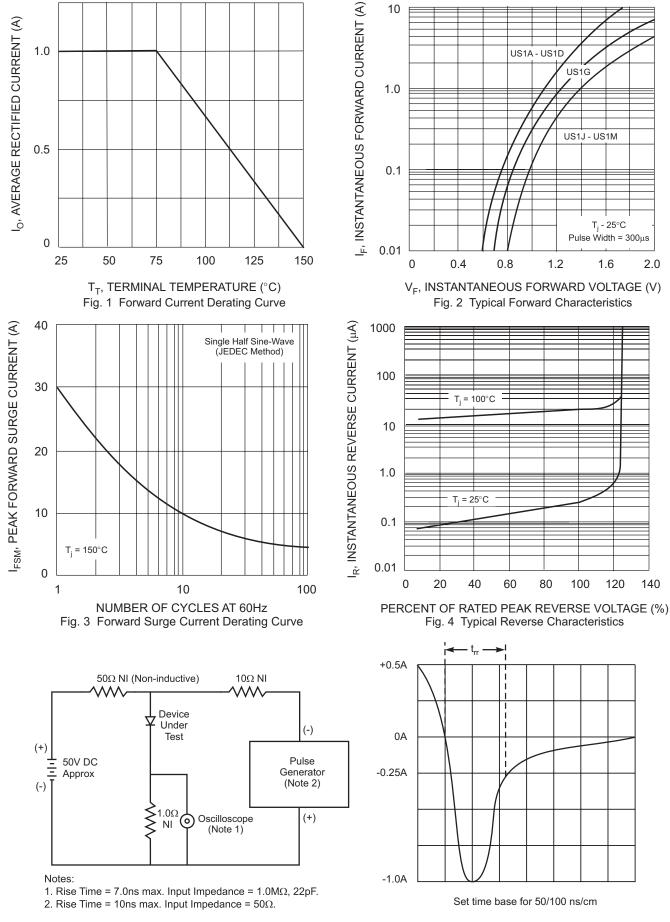


Fig. 5 Reverse Recovery Time Characteristic and Test Circuit



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